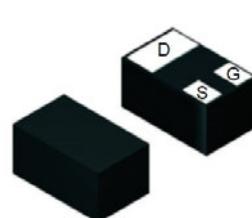
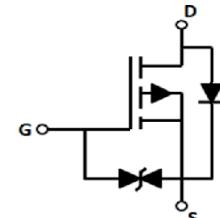


Main Product Characteristics

BV _{DSS}	-20V
R _{DS(ON)}	850mΩ (max.)
I _D	-0.56A



SOT-883



Schematic Diagram

Features and Benefits

- Advanced MOSFET process technology
- ESD Protection
- Low on-resistance with low gate charge
- Fast switching and reverse body recovery



Description

GSFW02056 is the P-Channel enhancement mode power field effect transistors with high cell density, trench technology. This high density process and design have been optimized switching performance and especially tailored to minimize on-state resistance.

Absolute Maximum Ratings ($T_A=25^\circ\text{C}$ unless otherwise specified)

Parameter	Symbol	Max.	Unit
Drain-Source Voltage	V _{DS}	-20	V
Gate-Source Voltage	V _{GS}	±10	V
Continuous Drain Current, ($T_A=25^\circ\text{C}$, $t \leq 5\text{s}$)	I _D	-0.56	A
Continuous Drain Current, @ Steady-State ($T_A=25^\circ\text{C}$)		-0.5	A
Continuous Drain Current, @ Steady-State ($T_A=75^\circ\text{C}$)		-0.39	A
Pulsed Drain Current ¹	I _{DM}	-2.24	A
Total Power Dissipation @ $T_A=25^\circ\text{C}$, $t \leq 5\text{s}^2$	P _D	430	mW
Total Power Dissipation @ $T_A=25^\circ\text{C}$, Steady-State ²		340	
Thermal Resistance Junction-to-Ambient @ $t \leq 5\text{s}^2$	R _{θJA}	294	°C/W
Thermal Resistance Junction-to-Ambient @ Steady State ²		366	
Junction and Storage Temperature Range	T _{J/T_{STG}}	-55 to +150	°C

Note:

1. Pulse test: pulse width $\leq 300\mu\text{s}$, duty cycle $\leq 2\%$.
2. Device mounted on FR-4 PCB, 1 inch x 0.85 inch x 0.062 inch. With 2oz Copper, $t \leq 10\text{s}$

Electrical Characteristics ($T_J=25^\circ\text{C}$ unless otherwise specified)

Parameter	Symbol	Conditions	Min	Typ	Max	Units
On / Off Characteristics						
Drain-Source Breakdown Voltage	BV_{DSS}	$V_{\text{GS}}=0\text{V}, I_{\text{D}}=-250\mu\text{A}$	-20	-	-	V
Zero Gate Voltage Drain Current	I_{DSS}	$V_{\text{DS}}=-20\text{V}, V_{\text{GS}}=0\text{V}, T_C=25^\circ\text{C}$	-	-	-1	μA
Gate-Body Leakage Current	I_{GSS}	$V_{\text{GS}}=\pm 10\text{V}, V_{\text{DS}}=0\text{V}$	-	-	± 10	uA
Gate Threshold Voltage	$V_{\text{GS}(\text{th})}$	$V_{\text{DS}}=V_{\text{GS}}, I_{\text{D}}=-250\mu\text{A}$	-0.35	-	-1.2	V
Static Drain-Source on-Resistance	$R_{\text{DS}(\text{on})}$	$V_{\text{GS}}=-4.5\text{V}, I_{\text{D}}=-0.5\text{A}$	-	610	850	$\text{m}\Omega$
		$V_{\text{GS}}=-2.5\text{V}, I_{\text{D}}=-0.3\text{A}$	-	930	1200	
Dynamic and Switching Characteristics						
Input Capacitance	C_{iss}	$V_{\text{DS}}=-10\text{V}, V_{\text{GS}}=0\text{V}, F=1\text{MHz}$	-	70	-	pF
Output Capacitance	C_{oss}		-	19	-	
Reverse Transfer Capacitance	C_{rss}		-	14	-	
Total Gate Charge	Q_g	$V_{\text{GS}}=-4.5\text{V}, V_{\text{DS}}=-10\text{V}, I_{\text{D}}=-0.5\text{A}$	-	1.22	-	nC
Gate Source Charge	Q_{gs}		-	0.36	-	
Gate Drain Charge	Q_{gd}		-	0.26	-	
Turn-on Delay Time	$t_{\text{d}(\text{on})}$	$V_{\text{GS}}=-4.5\text{V}, V_{\text{DD}}=-10\text{V}, R_L=2.5\Omega, R_{\text{GEN}}=2.5\Omega$	-	4.5	-	nS
Turn-on Rise Time	t_r		-	18	-	
Turn-off Delay Time	$t_{\text{d}(\text{off})}$		-	15	-	
Turn-off Fall Time	t_f		-	23	-	
Source-Drain Ratings and Characteristics						
Diode Forward Voltage	V_{SD}	$I_{\text{S}}=-0.56\text{A}, V_{\text{GS}}=0\text{V}$	-	-	-1.2	V
Maximum Body-Diode Continuous Current	I_{S}	-	-	-	-0.56	A

Typical Performance Characteristics

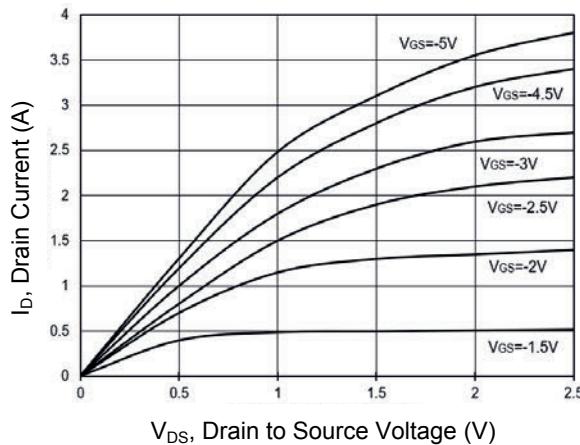


Figure 1. Output Characteristics

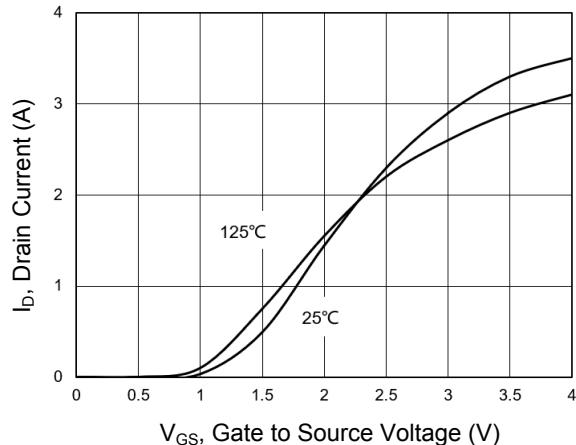


Figure 2. Transfer Characteristics

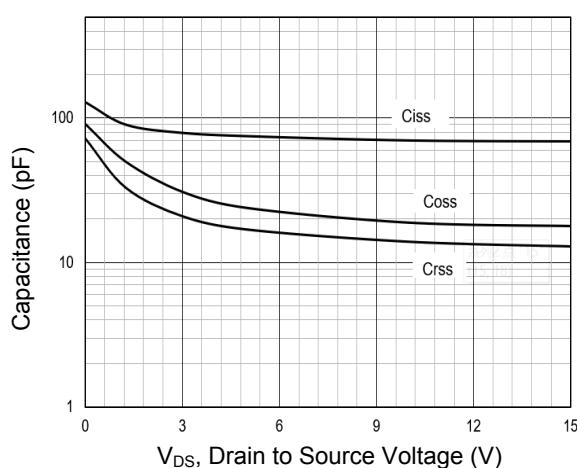


Figure 3. Capacitance Characteristics

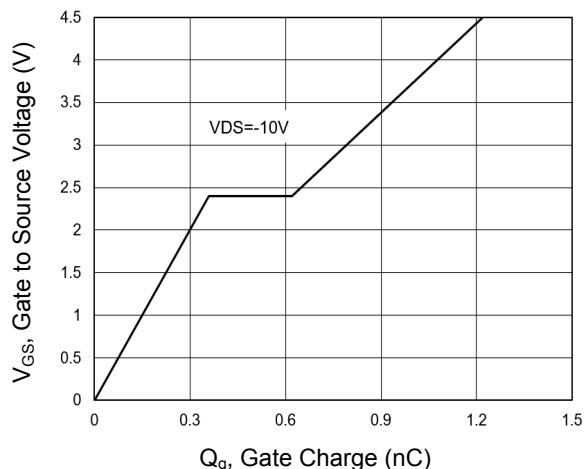


Figure 4. Gate Charge

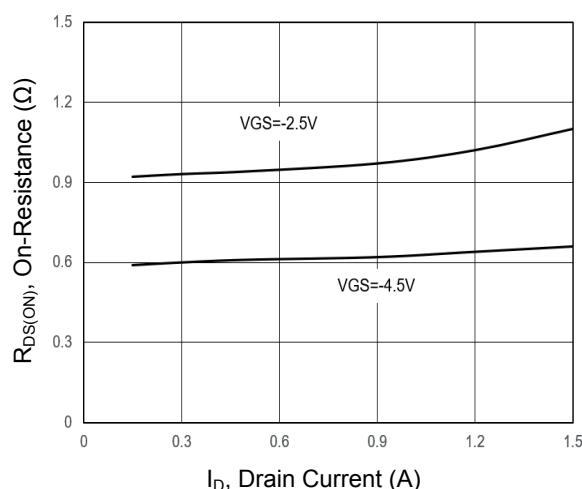


Figure 5. Drain to Source on Resistance

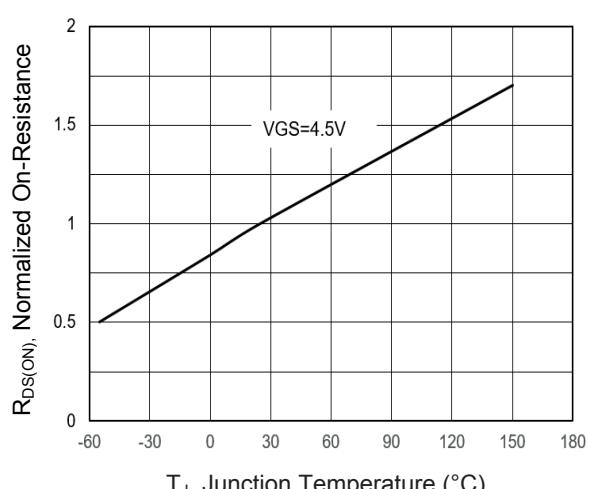
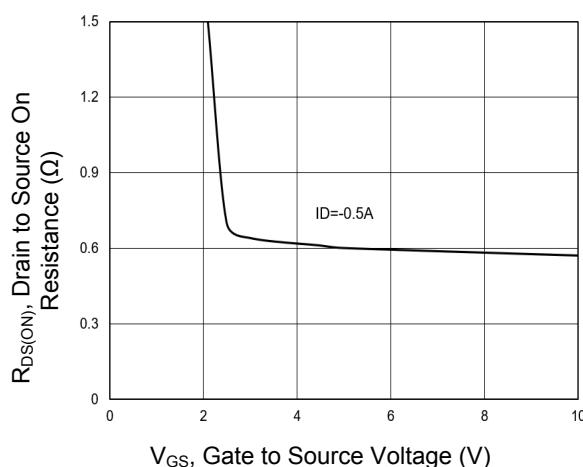


Figure 6. Normalized $R_{DS(ON)}$ vs. T_J

Typical Performance Characteristics



**Figure 7. Typical Drain to Source ON Resistance
vs. Gate Voltage and Drain Current**

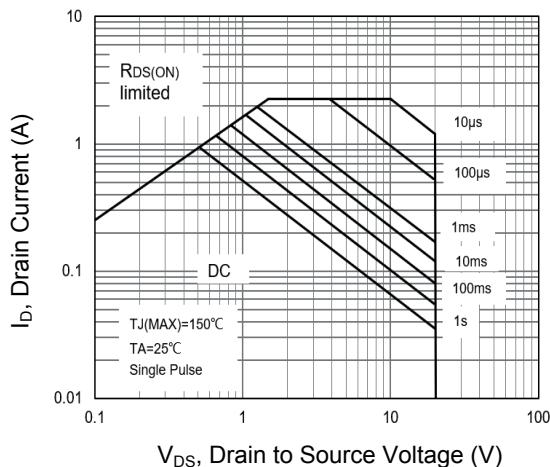


Figure 8. Safe Operation Area

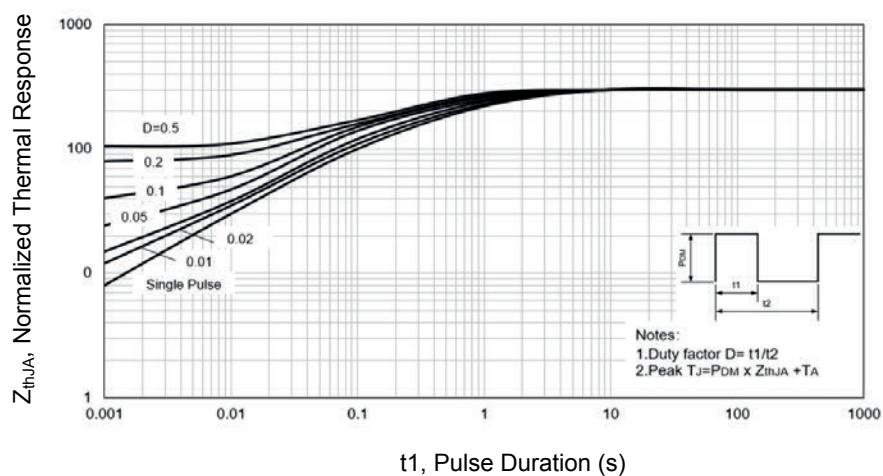
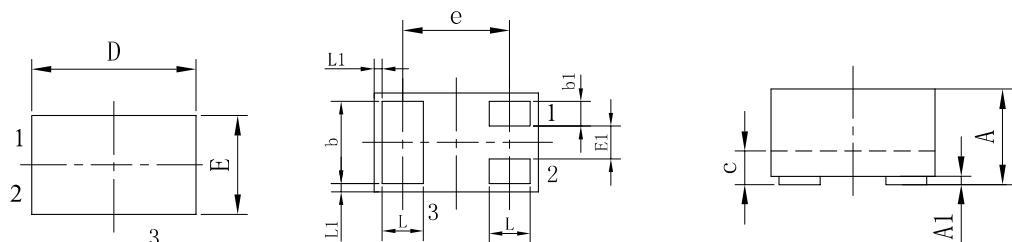


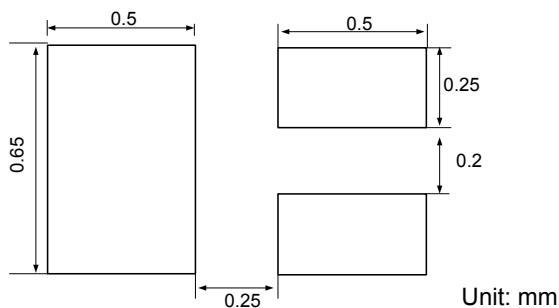
Figure 9. Maximum Effective Transient Thermal Impedance, Junction-to-Ambient

Package Outline Dimensions (DFN1006-3L)



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	0.45	0.55	0.018	0.022
A1	0.00	0.05	0.000	0.002
b	0.45	0.55	0.018	0.022
b1	0.10	0.20	0.004	0.008
c	0.12	0.18	0.005	0.007
D	0.95	1.05	0.037	0.041
e	0.65 BSC		0.026 BSC	
E	0.55	0.65	0.022	0.026
E1	0.15	0.25	0.006	0.010
L	0.20	0.30	0.008	0.012
L1	0.05 REF		0.002 REF	

Recommended Pad Layout



Order Information

Device	Package	Marking	Carrier	Quantity
GSFW02056	SOT-883	M5	Tape & Reel	10,000 pcs / 7" Reel